

500V N-Channel Enhancement Mode MOSFET

Description

The AP5N50BD is silicon N-channel Enhanced

VDMOSFETs, is obtained by the self-aligned planar Technology
which reduce the conduction loss, improve switching
performance and enhance the avalanche energy. The transistor
can be used in various power switching circuit for system
miniaturization and higher efficiency.



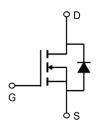
 $V_{DS} = 500V I_{D} = 5A$

 $R_{DS(ON)} < 3.0\Omega$ @ $V_{GS} \text{=} 10 \text{V}$ (Type: 2.4 Ω)

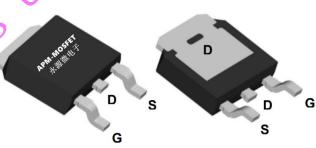


Uninterruptible Power Supply(UPS)

Power Factor Correction (PFC)







Package Marking and Ordering Information

Product ID	N	Pack	Marking	Qty(PCS)
AP5N50BD	5	TO-252-3L	AP5N50BD XXX YYYY	2500

Absolute Maximum Ratings (T_c=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
VDSS	Drain-Source Voltage (V _{GS} = 0V)	500	V
ID	Continuous Drain Current	5	А
IDM	Pulsed Drain Current (note1)	15	А
VGS	Gate-Source Voltage	±30	V
E _{AS}	Single Pulse Avalanche Energy (note2)	57	mJ
IAR	Avalanche Current (note1)	2.4	Α
Ear	Repetitive Avalanche Energy note1)	6.4	mJ
P _D	Power Dissipation (T _C = 25°C)	32.9	W
TJ, Tstg	Operating Junction and Storage Temperature Range	-55~+150	°C
RthJC	Thermal Resistance, Junction-to-Case	6.25	°C/W
RthJA	Thermal Resistance, Junction-to-Ambient	62.5	°C/W



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Electrical Characteristics (T_J=25°C, unless otherwise noted)

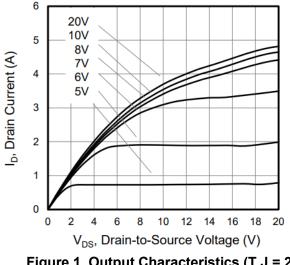
Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
V(BR)DSS	Drain-Source Breakdown Voltage V _{GS} = 0V, I _D = 250μA		500	550		V
IDSS	Zero Gate Voltage Drain Current	V _{DS} = 650V, V _{GS} = 0V, T _J =25°C			1	μA
IGSS	Gate-Source Leakage	V _{GS} = ±30V			±100	nA
VGS(th)	Gate-Source Threshold Voltage	V _{DS} = V _{GS} , I _D = 250µA	2.0	3.0	4.0	V
RDS(on)	Drain-Source On-Resistance (Note3)	V _{GS} = 10V, I _D = 3.5A		2.4	3.0	Ω
C _{iss}	Input Capacitance		4	310		
Coss	Output Capacitance	$V_{GS} = 0V$, $V_{DS} = 25V$, $f = 1.0MHz$		39		pF
Crss	Reverse Transfer Capacitance	O_{I} .		6		
Qg	Total Gate Charge			8		
Q _{gs}	Gate-Source Charge	V_{DD} =400V, I_D = 3A, V_{GS} = 10V		1.2		nC
Q_{gd}	Gate-Drain Charge			5		
td(on)	Turn-on Delay Time	5		7.8		
tr	Turn-on Rise Time	250V I = 24 B = 250		33		
td(off)	Turn-off Delay Time	V_{DD} =250V, I_D = 3A, R_G = 25Ω		23		ns
t _f	Turn-off Fall Time			59		
IS	Continuous Body Diode Current	T _C = 25 °C			3.0	Α
ISM	Pulsed Diode Forward Current	10 - 20 0			12	Α
V _{SD}	Body Diode Voltage	Body Diode Voltage T _J = 25°C, I _{SD} = 3A, V _{GS} = 0V			1.4	V
trr	Reverse Recovery Time	V _{GS} = 0V,I _S = 3A, di _F /dt =100A		80		ns
Qrr	Reverse Recovery Charge	/µs		1.8		μC

Note:

- 1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.
- 2. The EAS data shows Max. rating . IAS = 2.4A, VDD = 50V, RG = 25 Ω , Starting TJ = 25 $^{\circ}$ C
- 3、The lest condition is Pulse Test: Pulse width ≤ 300µs, Duty Cycle ≤ 1%
- 4. The power dissipation is limited by 150 ℃ junction temperature
- 5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

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Typical Characteristics



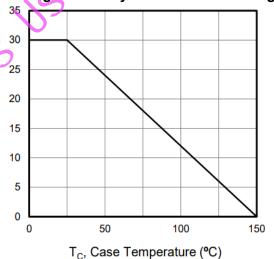
10¹ 10⁰ $T_{J} = 150^{\circ}C$ 10-1 $T_J = 25^{\circ}C$ 10-2 10-3 0.2 0.6 8.0 1.2 V_{SD}, Source-to-Drain Voltage (V)

Is, Source Current (A)

Figure 1. Output Characteristics (T J = 25°C)

P_D, Power Dissipation (w) D. Drain Current (A) 4 3

Figure 2. Body Diode Forward Voltage



T_C, Case Temperature (°C) Figure 3 Drain Current vs. Temperature

90

150

120

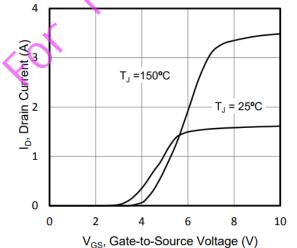


Figure 4. BV DSS Variation vs. Temperature

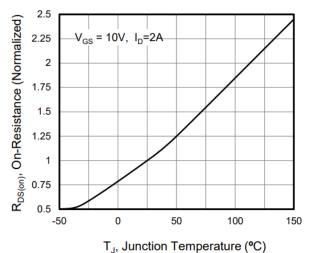


Figure 5. Transfer Characteristics

Figure 6. On-Resistance vs. Temperature

2

1

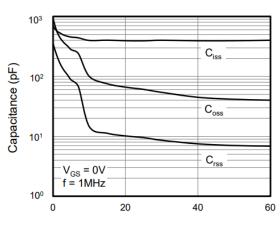
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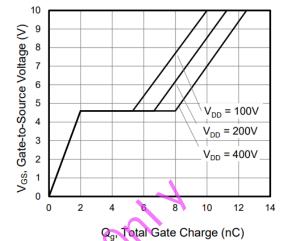
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30



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V_{DS}, Drain-to-Source Voltage (V)

Figure 8. Gate Charge



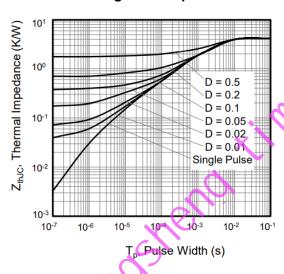
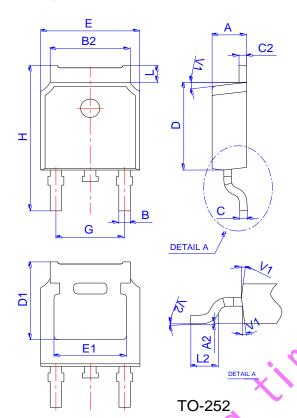


Figure 9. Transient Thermal Impedance



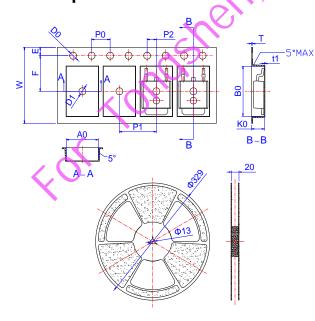
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Package Mechanical Data



			Dimensions			
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
Α	2.10		2.50	0.083		0.098
A2	0		0.10	0		0.004
В	0.66		0.86	0.026		0.034
B2	5.18		5.48	0.202		0.216
С	0.40		0.60	0.016		0.024
C2	0.44		0.58	0.017		0.023
D	5.90	_	6.30	0.232		0.248
D1	5.30REF			0.209REF		
E	6.40		6.80	0.252		0.268
E1	4.63	>-		0.182		
G	4.47)	4.67	0.176		0.184
Н	9.50		10.70	0.374		0.421
Ļ	1.09		1.21	0.043		0.048
2	1.35		1.65	0.053		0.065
V1		7°			7°	
V2	0°		6°	0°		6°

Reel Spectification-TO-252



	Dimensions					
Ref.	Millimeters			Inches		
	Min.	Тур.	Max.	Min.	Тур.	Max.
W	15.90	16.00	16.10	0.626	0.630	0.634
Е	1.65	1.75	1.85	0.065	0.069	0.073
F	7.40	7.50	7.60	0.291	0.295	0.299
D0	1.40	1.50	1.60	0.055	0.059	0.063
D1	1.40	1.50	1.60	0.055	0.059	0.063
P0	3.90	4.00	4.10	0.154	0.157	0.161
P1	7.90	8.00	8.10	0.311	0.315	0.319
P2	1.90	2.00	2.10	0.075	0.079	0.083
A0	6.85	6.90	7.00	0.270	0.271	0.276
В0	10.45	10.50	10.60	0.411	0.413	0.417
K0	2.68	2.78	2.88	0.105	0.109	0.113
Т	0.24		0.27	0.009		0.011
t1	0.10			0.004		
10P0	39.80	40.00	40.20	1.567	1.575	1.583



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Edition	Date	Change
Rve1.0	2021/4/31	Initial release

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